SCBS020A - SEPTEMBER 1988 - REVISED NOVEMBER 1993

- State-of-the-Art BiCMOS Design Significantly Reduces I_{CCZ}
- ESD Protection Exceeds 2000 V Per MIL-STD-883C, Method 3015
- Package Options Include Plastic Small-Outline (DW) Packages, Ceramic Chip Carriers (FK) and Flatpacks (W), and Plastic and Ceramic 300-mil DIPs (J, N)

description

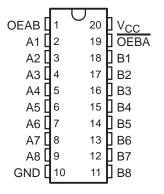
The 'BCT623 bus transceiver is designed for asynchronous communication between data buses. The control function implementation allows for maximum flexibility in timing. The 'BCT623 provides true data at its outputs.

This device allows data transmission from the A bus to the B bus or from the B bus to the A bus depending upon the <u>logic</u> levels at the output-enable (OEAB and OEBA) inputs.

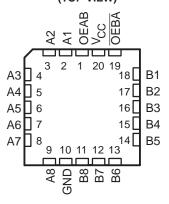
The output-enable inputs can be used to disable the device so that the buses are effectively isolated. The dual-enable configuration gives the transceivers the capability of storing data by simultaneously enabling OEAB and OEBA. Each output reinforces its input in this configuration. When both OEAB and OEBA are enabled and all other data sources to the two sets of bus lines are at high impedance, both sets of bus lines (16 in all) will remain at their last states.

The SN54BCT623 is characterized for operation over the full military temperature range of -55° C to 125°C. The SN74BCT623 is characterized for operation from 0°C to 70°C.

SN54BCT623 . . . J OR W PACKAGE SN74BCT623 . . . DW OR N PACKAGE (TOP VIEW)



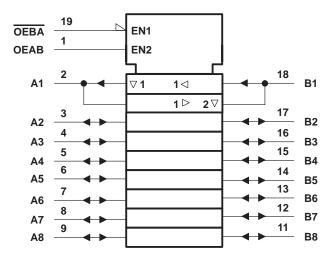
SN54BCT623 . . . FK PACKAGE (TOP VIEW)



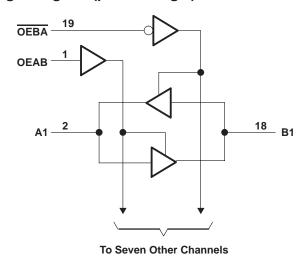
FUNCTION TABLE

INP	JTS	OPERATION						
OEBA	OEAB	OPERATION						
L	L	B data to A bus						
L	Н	B data to A bus, A data to B bus						
Н	L	Isolation						
Н	Н	A data to B bus						

logic symbol†



logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage range, V _{CC}	– 0.5 V to 7 V
Input voltage range: Control inputs (see No	te 1)
I/O ports (see Note 1)	– 0.5 V to 5.5 V
Voltage range applied to any output in the d	isabled or power-off state, V _O – 0.5 V to 5.5 V
Voltage range applied to any output in the h	igh state, V _O – 0.5 V to V _{CC}
Input clamp current, I _{IK}	-30 mA
Current into any output in the low state: SN	54BCT623 96 mA
SN'	74BCT623 128 mA
Operating free-air temperature range: SN	54BCT623 – 55°C to 125°C
SN'	74BCT6230°C to 70°C
Storage temperature range	– 65°C to 150°C

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

			SN	SN54BCT623			SN74BCT623		
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage		4.5	5	5.5	4.5	5	5.5	V
VIН	High-level input voltage		2			2			V
VIL	Low-level input voltage			8.0			8.0	V	
lik	Input clamp current			-18			-18	mA	
		A port			-3			-3	
ЮН	High-level output current	B port			-12			-15	mA
		A port			20			24	
lOL	Low-level output current B port				48			64	mA
TA	Operating free-air temperature	-55		125	0		70	°C	



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

NOTE 1: The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			T CONDITIONS	SN	I54BCT6	23	SN				
		TES	MIN	TYP†	MAX	MIN	TYP [†]	MAX	UNIT		
		V _{CC} = 4.5 V,	I _I = -18 mA			-1.2			-1.2	V	
	A =====	V 45V	$I_{OH} = -1 \text{ mA}$	2.5	3.4		2.5	3.4			
	A port	$V_{CC} = 4.5 \text{ V}$	$I_{OH} = -3 \text{ mA}$	2.4	3.3		2.4	3.3		V	
Vон			$I_{OH} = -3 \text{ mA}$	2.4	3.3		2.4	3.3			
	B port	V _{CC} = 4.5 V	$I_{OH} = -12 \text{ mA}$	2	3.2						
			$I_{OH} = -15 \text{ mA}$				2	3.1			
	A port	V00 - 45 V	$I_{OL} = 20 \text{ mA}$		0.3	0.5					
V	A port	V _{CC} = 4.5 V	$I_{OL} = 24 \text{ mA}$					0.35	0.5	V	
V_{OL}	B port	V _{CC} = 4.5 V	$I_{OL} = 48 \text{ mA}$		0.38	0.55				V	
	Б роп	vCC = 4.5 v	$I_{OL} = 64 \text{ mA}$					0.42	0.55		
1.	A or B port	V _{CC} = 5.5 V,	V _I = 5.5 V			1			1	mA	
II	OEAB or OEBA	VCC = 5.5 V,	v = 5.5 v			0.1			0.1		
I _{IH} ‡	A or B port	V00 - 5 5 V	V _I = 2.7 V			70			70		
ΠΗ ⁺	OEAB or OEBA	V _{CC} = 5.5 V,	V = 2.7 V			20			20	μΑ	
I _{IL} ‡	A or B port	V _{CC} = 5.5 V,	$V_{I} = 0.5 \text{ V}$			-0.65			-0.65	mA	
ΊL™	OEAB or OEBA	VCC = 5.5 V,	V = 0.5 V			-0.6			-0.6	IIIA	
los§	A port	V _{CC} = 5.5 V,	$V_{O} = 0$	-60		-150	-60		-150	mA	
1083	B port	vCC = 5.5 v,	νO = 0	-100		-225	-100		-225	IIIA	
ICCL	A to B	V _{CC} = 5.5 V			58	92		58	92	mA	
ICCH	A to B	V _{CC} = 5.5 V			33	53		33	53	mA	
Iccz		V _{CC} = 5.5 V			6	11		6	11	mA	
Ci	OEAB or OEBA	$V_{CC} = 5 V$,	$V_{I} = 2.5 \text{ V or } 0.5 \text{ V}$		5			5		pF	
C _{io}	A to B	V _{CC} = 5 V,	V _O = 2.5 V or 0.5 V		9			9		nF.	
O10	B to A	VCC = 3 V	V () = 2.5 V () (0.5 V		12			12		pF	

[†] All typical values are at V_{CC} = 5 V, T_A = 25°C. ‡ For I/O ports, the parameters I_{IH} and I_{IL} include the off-state output current. § Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

SN54BCT623, SN74BCT623 OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

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switching characteristics (see Note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V_{CC} = 5 V, C_{L} = 50 pF, R1 = 500 Ω, R2 = 500 Ω, T_{A} = 25°C			$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$ $C_L = 50 \text{ pF},$ $R1 = 500 \Omega,$ $R2 = 500 \Omega,$ $T_A = \text{MIN to MAX}^{\dagger}$				UNIT
			′BCT623			SN54B	CT623	SN74BCT623		
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t _{PLH}		Б	0.5	3.1	4.7	0.5	5.3	0.5	5.2	ns
tpHL	А	В	1.7	4.9	6.9	1.7	7.6	1.7	7.4	
t _{PLH}		^	0.9	4.1	5.9	0.9	6.8	0.9	6.7	ns
tpHL	В	А	1.8	5.3	7.6	1.8	8.3	1.8	8	
^t PZH	OEBA	А	3.1	6.8	9.1	3.1	10.7	3.1	10.6	ns
t _{PZL}	OEBA		3.3	7.2	9.6	3.3	11.3	3.3	10.7	
t _{PHZ}	OEBA		1.9	6.1	8.3	1.9	10.6	1.9	9.8	
tPLZ	OEBA	А	1.1	4.6	7	1.1	8.1	1.1	7.8	ns
^t PZH	OFAR		2	5	6.8	2	7.8	2	7.6	ns
t _{PZL}	OEAB	В	2.7	6.2	8	2.7	9.3	2.7	8.9	
t _{PHZ}	OEAB	В	1.1	4.6	6.5	1.1	8	1.1	7.7	ns
t _{PLZ}	UEAD	D	0.3	3.2	6.3	0.3	7.2	0.3	7.1	

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. NOTE 2: Load circuits and voltage waveforms are shown in Section 1.





PACKAGE OPTION ADDENDUM

6-Feb-2020

PACKAGING INFORMATION

Orderable Device		Package Type		Pins	_		Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
5962-9094001MRA	ACTIVE	CDIP	J	20	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-9094001MR A SNJ54BCT623J	Samples
SNJ54BCT623J	ACTIVE	CDIP	J	20	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-9094001MR A SNJ54BCT623J	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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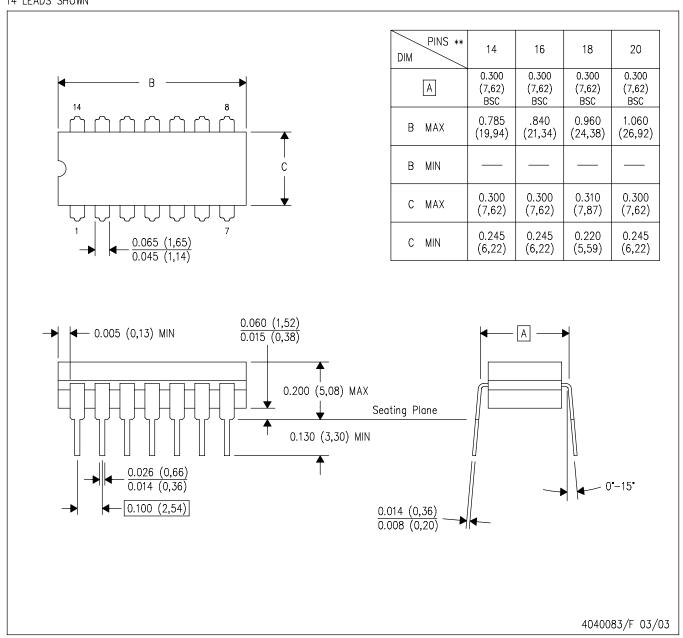


PACKAGE OPTION ADDENDUM

6-Feb-2020

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

14 LEADS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

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